

**THERMOPLASTIC MOLDING COMPOSITIONS HAVING REDUCED
WATER ABSORPTION**

ABSTRACT OF THE DISCLOSURE

A thermoplastic molding composition comprising polycarbonate and at least one (co)polyformal is disclosed. Characterized by its low water absorption the composition is particularly suitable for producing molded articles, especially optical data carriers, such as compact disks, video disks, digital versatile disks and optical data carriers that are writable and erasable once or repeatedly.